

NCE Automotive N-Channel Super Trench Power MOSFET

Description

The NCEAP40ND80G uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- Automotive application
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

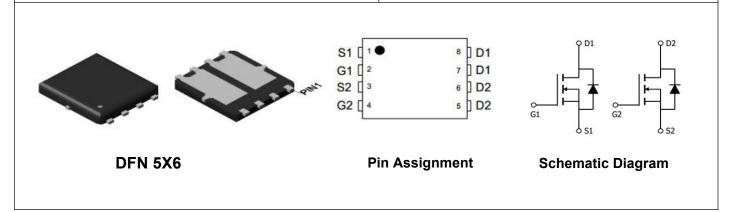
General Features

V_{DS} =40V,I_D =90A

 $R_{DS(ON)}$ =4.3m Ω (typical) @ V_{GS} =10V

 $R_{DS(ON)}$ =5.5m Ω (typical) @ V_{GS} =4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested
- 100% ΔVds tested
- AEC-Q101 qualified



Package Marking and Ordering Information

I	Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
	AP40ND80G	NCEAP40ND80G	DFN5x6-8L	Ø330mm	12mm	5000units

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	40	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	90	А
Drain Current-Continuous(T _C =100 °C)	I _D (100°C)	65	А
Pulsed Drain Current	I _{DM}	360	А
Maximum Power Dissipation	P _D	83	W
Derating factor		0.56	W/°C
Single pulse avalanche energy (Note 1)	Eas	500	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	Rejc	1.8	°C/W

NCEAP40ND80G

Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	40	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics	,					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_D=250\mu A$	1.0	1.6	2.2	V
Davis Course On Otata Basistana	Б	V _{GS} =10V, I _D =20A	-	4.3	5.0	mΩ
Drain-Source On-State Resistance	R _{DS(ON)} V _{GS} =4.5V, I _D =20A V _{DS} =5V,I _D =20A C _{Iss} C _{Iss}	-	5.5	6.5	mΩ	
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	-	60	-	S
Dynamic Characteristics			'			1
Input Capacitance	C _{lss}	.,	-	2300	-	pF
Output Capacitance	Coss	V_{DS} =20V, V_{GS} =0V,	-	740	-	pF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	38	-	pF
Switching Characteristics (Note 2)	,		'			•
Turn-on Delay Time	t _{d(on)}		-	7.5	-	nS
Turn-on Rise Time	t _r	$V_{DD} = 20V, I_D = 20A$	-	4.0	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10 V , R_{G} =1.6 Ω	-	37	-	nS
Turn-Off Fall Time	t _f		-	7.5	-	nS
Total Gate Charge	Qg	.,	-	34.8	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =20 V , I_{D} =20 A ,	-	6.2	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	5.1	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current	Is		-	-	90	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-	14	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	21	-	nC

Notes:

^{1.} EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=20V,VG=10V,L=0.5mH,Rg=25 Ω

^{2.} Guaranteed by design, not subject to production

^{3.} These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heat sink, assuming a maximum junction temperature of T_{J(MAX)}=175°C. The SOA curve provides a single pulse rating.



Typical Electrical and Thermal Characteristics

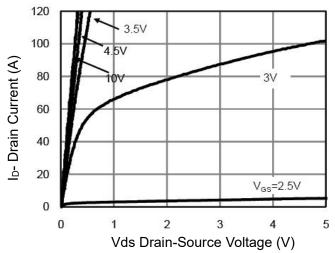


Figure 1 Output Characteristics

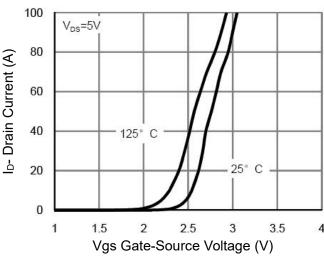


Figure 2 Transfer Characteristics

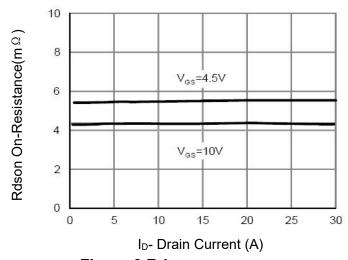


Figure 3 Rdson- Drain Current

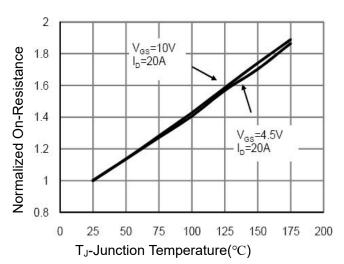
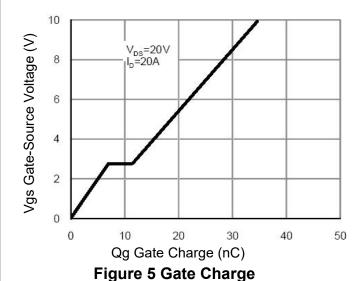


Figure 4 Rdson-Junction Temperature



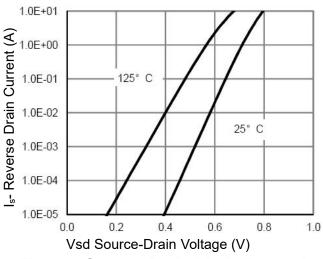


Figure 6 Source- Drain Diode Forward



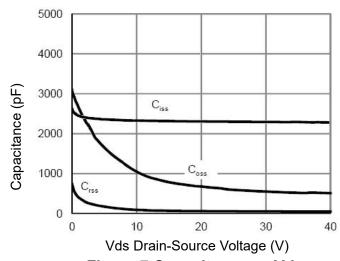


Figure 7 Capacitance vs Vds

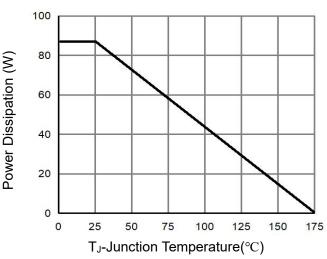


Figure 9 Power De-rating

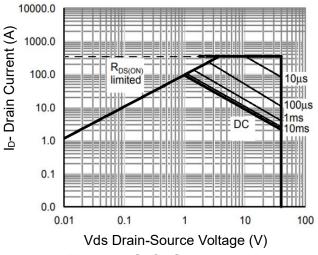


Figure 8 Safe Operation Area

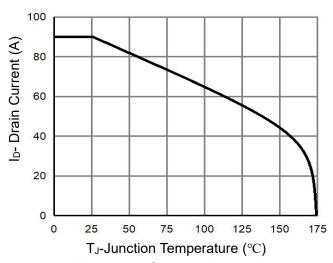


Figure 10 Current De-rating

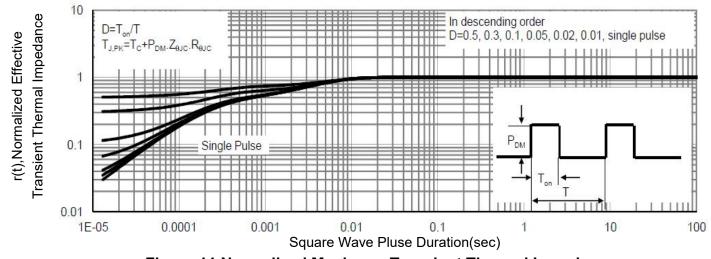
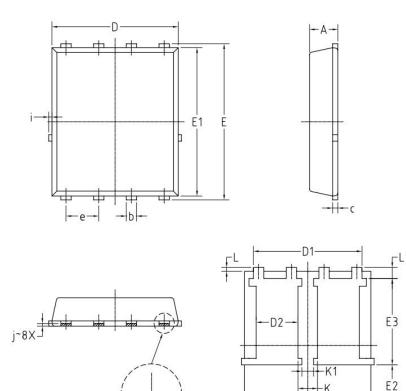


Figure 11 Normalized Maximum Transient Thermal Impedance

Plated Area



DFN5X6-8L Package Information



S Y	COMMON					
M B	MM		INCH			
B 0 L	MIN.	MAX.	MIN.	MAX.		
A	1.00	1.20	0.039	0.047		
Ь	0.30	0.50	0.012	0.020		
С	0.203 BSC		0.008 BSC			
D	4.80	5.00	0.189	0.197		
D1	4.06	4.36	0.160	0.172		
D2	1.47	1.77	0.058	0.070		
Е	5.90	6.20	0.232	0.244		
E1	5.65	5.85	0.222	0.230		
E2	1.45	s—-	0.057	-		
E3	3.20	3.50	0.126	0.138		
e	1.27	BSC	0.05 BSC			
L	0.05	0.25	0.002	0.010		
L1	0.325	0.525	0.013	0.021		
L2	0.500	0.800	0.020	0.031		
i	1 2	0.20	_	0.008		
K	0.61	0.91	0.024	0.036		
K1	0.31	0.60	0.012	0.024		
j	0.101	0.1015 BSC		0.004BSC		

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NCEAP40ND80G

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